SLLS123B - D2845, JUNE 1984 - REVISED FEBRUARY 1993

- Meets EIA Standards RS-422A, RS423A, and CCITT Recommendations V.11 and X.27
- Bus Voltage Range . . . –7 V to 12 V
- Positive and Negative Current Limiting
- Driver Output Capability . . . 60 mA Max
- Driver Thermal Shutdown Protection
- Receiver Input Impedance . . . 12 k $\Omega$  Min
- Receiver Input Sensitivity . . . ±200 mV
- Receiver Input Hysteresis . . . 50 mV Typ
- Operates From Single 5-V Supply
- Low Power Requirements

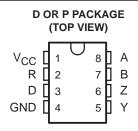
#### description

The SN75179A driver and bus receiver circuit is a monolithic integrated device designed for balanced transmission line applications, and meets EIA Standards RS-422A, RS-423A, and CCITT Recommendations V.11 and X.27. It is designed to improve the performance of data communications over long bus lines.

The SN75179A features positive- and negativecurrent limiting for the driver and receiver. The receiver features high input impedance, input hysteresis for increased noise immunity, and input sensitivity of  $\pm 200$  mV over a common-mode input voltage range of -12 V to 12 V.

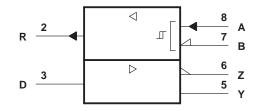
The driver provides thermal shutdown for protection from line fault conditions. Thermal shutdown is designed to occur at a junction temperature of approximately 150°C. The device is designed to drive current loads of up to 60 mA maximum.

The SN75179A is characterized for operation from 0°C to 70°C.

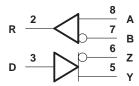


#### NOT RECOMMENDED FOR NEW DESIGN

### logic symbol



## logic diagram



DRIVER						
INPUT OUTPUTS						
D	ΥΖ					
Н	ΗL					
L	LH					

### **Function Tables**

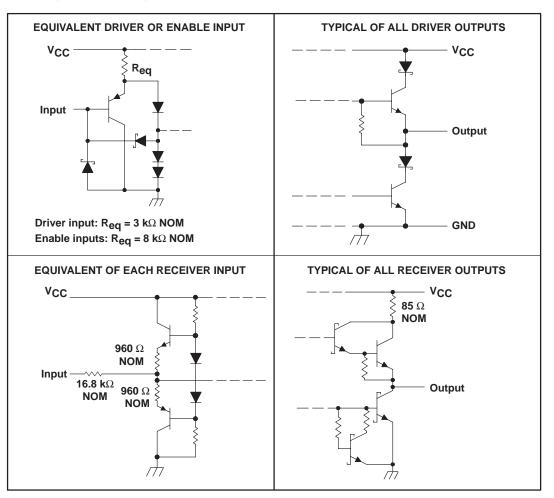
RECEIVI	ER
DIFFERENTIAL INP A – B	UTS OUTPUT R
$V_{ID} \ge 0.2 V$	н
-0.2 V < V <sub>ID</sub> < 0.2	2V ?
$V_{ID} \le -0.2 V$	L

H = high level, L = low level, ? = indeterminate



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### schematics of inputs and outputs



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>CC</sub> (see Note 1)	
Voltage range at any bus terminal	–10 V to 15 V
Differential input voltage (see Note 2)	±25 V
Continuous total dissipation	
Operating free-air temperature range	0°C to 70°C

NOTES: 1. All voltage values, except differential input voltage, are with respect to network ground terminal.

2. Differential-input voltage is measured at the noninverting input with respect to the corresponding inverting input.

### DISSIPATION RATING TABLE

PACKAGE	$T_A \le 25^{\circ}C$ POWER RATING	DERATING FACTOR ABOVE T <sub>A</sub> = 25°C	T <sub>A</sub> = 70°C POWER RATING						
D	725 mW	5.8 mW/°C	464 mW						
Р	1000 mW	8.0 mW/°C	640 mW						



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#### recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>	_	4.5	5	5.25	V
High-level input voltage, VIH	Driver	2			V
Low-level input voltage, VIL	Driver			0.8	V
Common-mode input voltage, VIC		_7†		12	V
Differential input voltage, VID				±12	V
	Driver			-60	mA
High-level output current, IOH	Receiver			-400	μA
	Driver			60	
Low-level output current, IOL	Receiver			8	mA
Operating free-air temperature, TA		0		70	°C

<sup>†</sup> The algebraic convention, where the less-positive (more-negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage.

## **DRIVER SECTION**

# electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

	PARAMETER	TEST CC	NDITIONS	MIN	TYP‡	MAX	UNIT
VIK	Input clamp voltage	II = -18 mA				-1.5	V
V <sub>OH</sub>	High-level output voltage	V <sub>IH</sub> = 2 V, I <sub>OH</sub> = -33 mA	V <sub>IL</sub> = 0.8 V,		3.7		V
V <sub>OL</sub>	Low-level output voltage	V <sub>IH</sub> = 2 V, I <sub>OH</sub> = 33 mA	$V_{IL} = 0.8 V,$		1.1		V
VOD1	Differential output voltage	IO = 0				2 V <sub>OD2</sub>	V
NZ 1		RL = 100 Ω,	See Figure 13	2	2.7		N
VOD2	Differential output voltage	RL = 54 Ω,	See Figure 13	1.5	2.4		V
$\Delta  V_{OD} $	Change in magnitude of differential output voltage§					±0.2	V
V <sub>OC</sub>	Common-mode output voltage¶	$R_L = 54 \Omega$ or 100 Ω,	See Flgure 13			3	V
$\Delta  V_{OC} $	Change in magnitude of common-mode output voltage§					±0.2	V
IO	Output current with power off	$V_{CC} = 0,$	$V_{O} = -7 V$ to 12 V			±100	μΑ
IIН	High-level input current	VI = 2.4 V				20	μΑ
IIГ	Low-level input current	VI = 0.4 V				-400	μΑ
		V <sub>O</sub> = -7 V				-250	
los	Short-circuit output current	AO = ACC	VO = VCC			250	mA
		V <sub>O</sub> = 12 V				500	
ICC	Supply current (total package)	No load				50	mA

<sup>‡</sup> All typical values are at V<sub>CC</sub> = 5 V and T<sub>A</sub> = 25°C.

§ Δ|V<sub>OD</sub>| and Δ|V<sub>OC</sub>| are the changes in magnitude of V<sub>OD</sub> and V<sub>OC</sub>, respectively, that occur when the input is changed from a high level to a low level.

In EIA Standard RS-422A, V<sub>OC</sub>, which is the average of the two output voltages with respect to ground, is called output offset voltage, V<sub>OS</sub>.

## switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<sup>t</sup> dD	Differential-output delay time			40	60	ns
<sup>t</sup> tD	Differential-output transition time	$R_L = 60 \Omega$ , See Figure 3		65	95	ns



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## **RECEIVER SECTION**

# electrical characteristics over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature (unless otherwise noted)

	PARAMETER	TES	ST CONDITIONS	MIN	TYP†	MAX	UNIT
$V_{T+}$	Positive-going threshold voltage	V <sub>O</sub> = 2.7 V,	$I_{O} = -0.4 \text{ mA}$			0.2	V
$V_{T-}$	Negative-going threshold voltage	V <sub>O</sub> = 0.5 V,	I <sub>O</sub> = 8 mA	-0.2‡			V
V <sub>hys</sub>	Hysteresis (V <sub>T+</sub> – V <sub>T–</sub> )	See Figure 9			50		mV
Vон	High-level output voltage	V <sub>ID</sub> = 200 mV, See Figure 2	I <sub>OH</sub> = -400 μA,	2.7			V
VOL	Low-level output voltage	$V_{ID} = -200 \text{ mV},$	IOL = 8 mA, See Figure 2			0.45	V
	1 to a famout command	Other input at 0 V,	V <sub>I</sub> = 12 V			1	
1	Line input current	See Note 3	$V_{I} = -7 V$			-0.8	mA
ri	Input resistance			12			kΩ
IOS	Short-circuit output current			-15		-85	mA
ICC	Supply current ( total package)	No load				50	mA

<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. <sup>‡</sup> The algebraic convention, where the less-positive (more-negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage levels only.

NOTE 3: Refer to EIA Standard RS-422A for exact conditions.

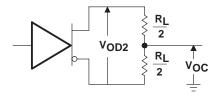
## switching characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = $25^{\circ}$ C

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t <sub>PLH</sub>	Propagation delay time, low-to-high-level output	$V_{ID} = -1.5 V$ to 1.5 V, $C_{L} = 15 pF$ ,		26	35	ns
<sup>t</sup> PHL	Propagation delay time, high-to-low-level output	See Figure 5		27	35	ns

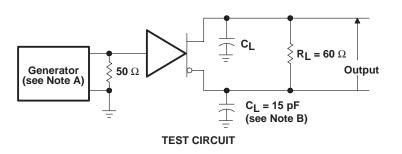


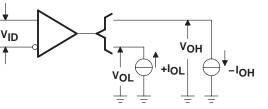
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## PARAMETER MEASUREMENT INFORMATION

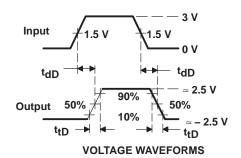


## Figure 1. Driver VOD and VOC





#### Figure 2. Receiver VOH and VOL



## Figure 3. Driver Differential-Output Delay and Transition Times

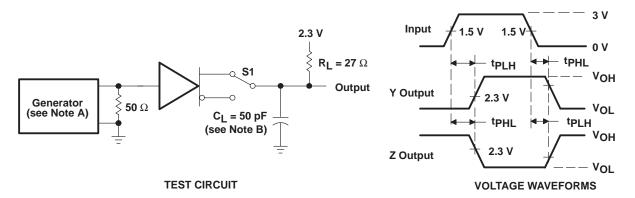


Figure 4. Driver Test Circuit and Voltage Waveforms

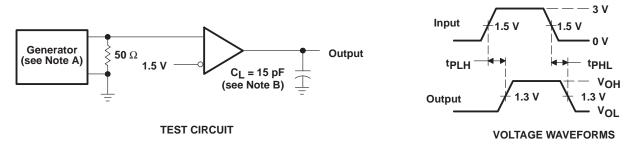
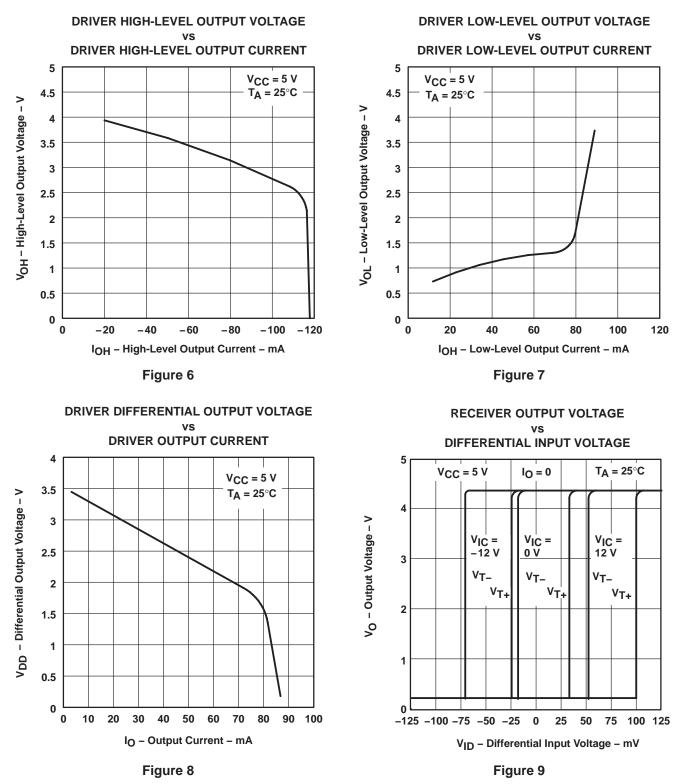


Figure 5. Receiver Test Circuit and Voltage Waveforms

- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, 50% duty cycle,  $t_f \le 6$  ns,  $t_f \le 6$  ns,  $Z_O = 50 \Omega$ .
  - B. CL includes probe and jig capacitance.

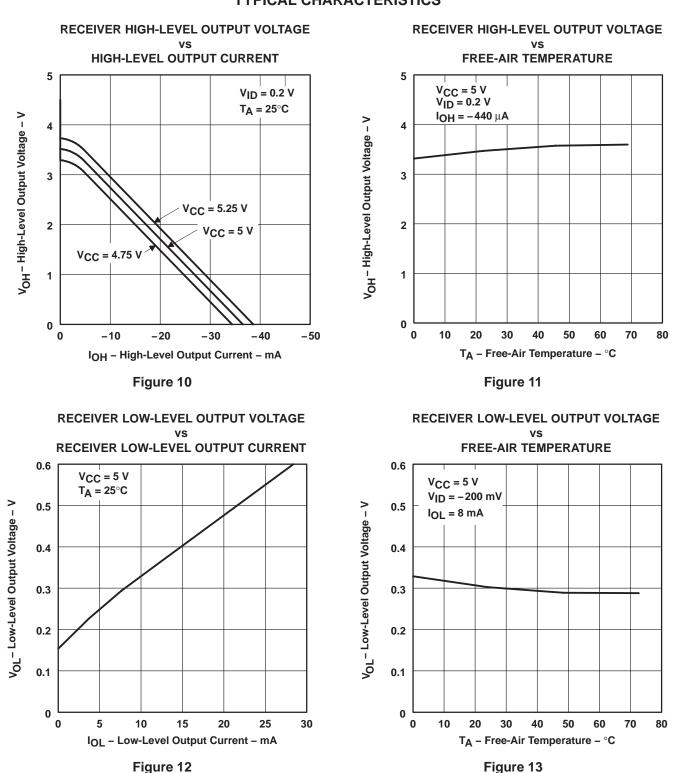


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## **TYPICAL CHARACTERISTICS**

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## PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	e Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/ Ball Finish	MSL Peak Temp <sup>(3)</sup>	Samples (Requires Login)
SN75179AP	OBSOLETE	PDIP	Р	8		TBD	Call TI	Call TI	Samples Not Available

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

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<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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P(R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 variation BA.



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